

Electronic Acknowledgement Receipt

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Title of Invention:	Silicon-germanium thin layer semiconductor structure with variable silicon-germanium composition and method of fabrication
First Named Inventor:	Pradip K. Roy
Customer Number:	37694
Filer:	Kristi Lynn Davidson/Debbie Goodman
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages

1	Request for Continued Examination (RCE)	TTCA-008_RCE.pdf	218740	no	1
Warnings:					
Information:					
2	Fee Worksheet (PTO-875)	fee-info.pdf	8209	no	2
Warnings:					
Information:					
Total Files Size (in bytes):				226949	
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